

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ( $\pi$ -MOSV)

# 2SK2915

Chopper Regulator, DC-DC Converter and Motor Drive Applications

Unit: mm

- Low drain-source ON resistance :  $R_{DS(ON)} = 0.31 \Omega$  (typ.)
- High forward transfer admittance :  $|Y_{fs}| = 15 \text{ S}$  (typ.)
- Low leakage current :  $I_{DSS} = 100 \mu\text{A}$  (max) ( $V_{DS} = 600 \text{ V}$ )
- Enhancement mode :  $V_{th} = 2.0 \sim 4.0 \text{ V}$  ( $V_{DS} = 10 \text{ V}$ ,  $I_D = 1 \text{ mA}$ )

## Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

| Characteristics                                      |                | Symbol    | Rating         | Unit             |
|------------------------------------------------------|----------------|-----------|----------------|------------------|
| Drain-source voltage                                 |                | $V_{DSS}$ | 600            | V                |
| Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ ) |                | $V_{DGR}$ | 600            | V                |
| Gate-source voltage                                  |                | $V_{GSS}$ | $\pm 30$       | V                |
| Drain current                                        | DC (Note 1)    | $I_D$     | 16             | A                |
|                                                      | Pulse (Note 1) | $I_{DP}$  | 64             |                  |
| Drain power dissipation ( $T_c = 25^\circ\text{C}$ ) |                | $P_D$     | 150            | W                |
| Single pulse avalanche energy (Note 2)               |                | $E_{AS}$  | 1026           | mJ               |
| Avalanche current                                    |                | $I_{AR}$  | 16             | A                |
| Repetitive avalanche energy (Note 3)                 |                | $E_{AR}$  | 15             | mJ               |
| Channel temperature                                  |                | $T_{ch}$  | 150            | $^\circ\text{C}$ |
| Storage temperature range                            |                | $T_{stg}$ | $-55 \sim 150$ | $^\circ\text{C}$ |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

## Thermal Characteristics

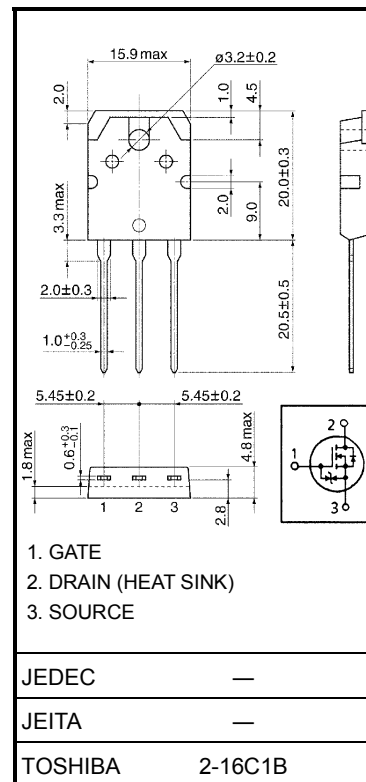
| Characteristics                        | Symbol         | Max   | Unit                        |
|----------------------------------------|----------------|-------|-----------------------------|
| Thermal resistance, channel to case    | $R_{th(ch-c)}$ | 0.833 | $^\circ\text{C} / \text{W}$ |
| Thermal resistance, channel to ambient | $R_{th(ch-a)}$ | 50    | $^\circ\text{C} / \text{W}$ |

Note 1: Ensure that the channel temperature does not exceed  $150^\circ\text{C}$ .

Note 2:  $V_{DD} = 90 \text{ V}$ ,  $T_{ch} = 25^\circ\text{C}$  (initial),  $L = 7.01 \text{ mH}$ ,  $R_G = 25 \Omega$ ,  $I_{AR} = 16 \text{ A}$

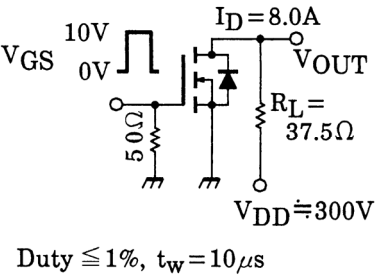
Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.  
Please handle with caution.



Weight: 4.6 g (typ.)

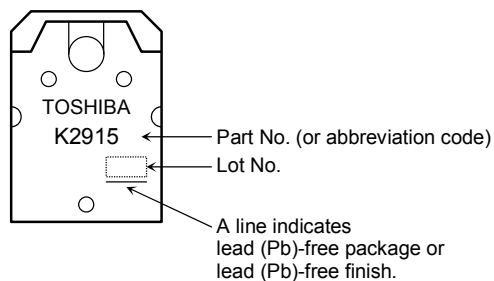
## Electrical Characteristics (Ta = 25°C)

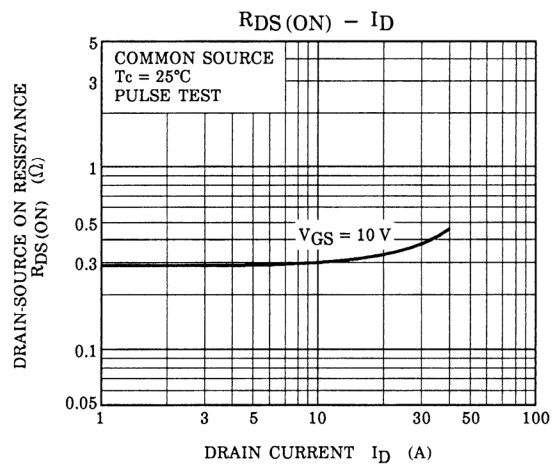
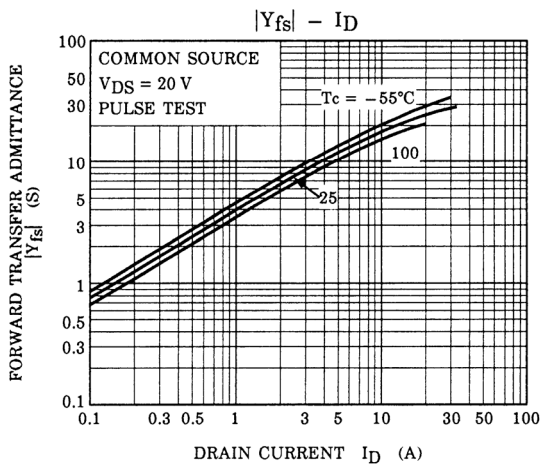
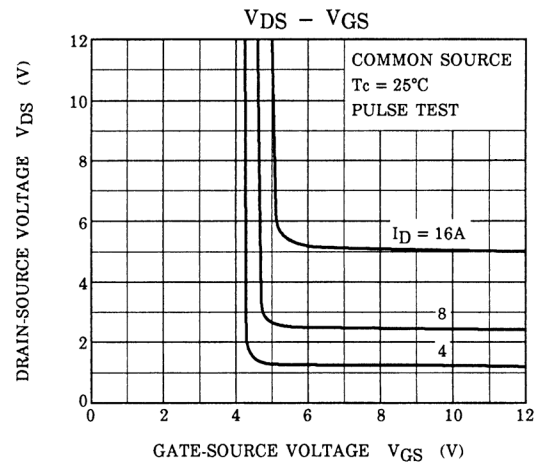
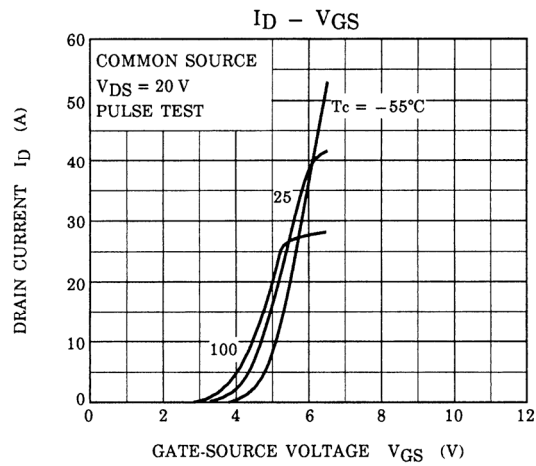
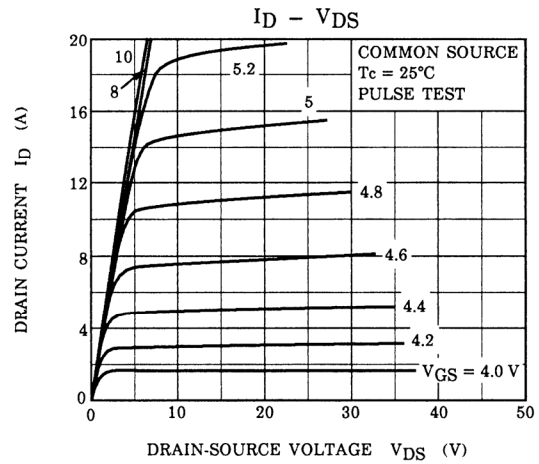
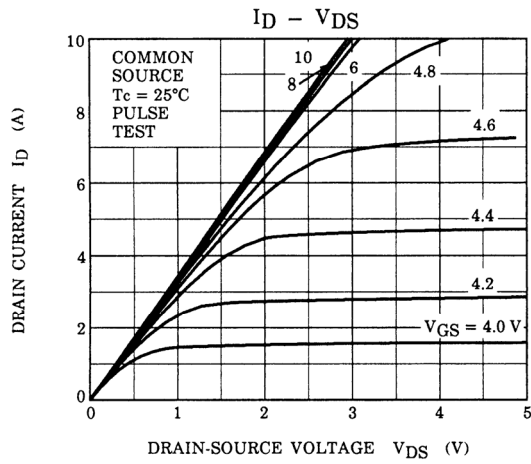
| Characteristics                                 |               | Symbol         | Test Condition                                                                                                                                                                                                                                                                | Min      | Typ. | Max      | Unit          |
|-------------------------------------------------|---------------|----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------|----------|---------------|
| Gate leakage current                            |               | $I_{GSS}$      | $V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$                                                                                                                                                                                                                             | —        | —    | $\pm 10$ | $\mu\text{A}$ |
| Gate-source breakdown voltage                   |               | $V_{(BR) GSS}$ | $I_G = \pm 10 \mu\text{A}, V_{DS} = 0 \text{ V}$                                                                                                                                                                                                                              | $\pm 30$ | —    | —        | V             |
| Drain cut-off current                           |               | $I_{DSS}$      | $V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$                                                                                                                                                                                                                                | —        | —    | 100      | $\mu\text{A}$ |
| Drain-source breakdown voltage                  |               | $V_{(BR) DSS}$ | $I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$                                                                                                                                                                                                                                   | 600      | —    | —        | V             |
| Gate threshold voltage                          |               | $V_{th}$       | $V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$                                                                                                                                                                                                                                   | 2.0      | —    | 4.0      | V             |
| Drain-source ON resistance                      |               | $R_{DS(ON)}$   | $V_{GS} = 10 \text{ V}, I_D = 8.0 \text{ A}$                                                                                                                                                                                                                                  | —        | 0.31 | 0.4      | $\Omega$      |
| Forward transfer admittance                     |               | $ Y_{fs} $     | $V_{DS} = 10 \text{ V}, I_D = 8.0 \text{ A}$                                                                                                                                                                                                                                  | 8.0      | 15.0 | —        | S             |
| Input capacitance                               |               | $C_{iss}$      | $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$                                                                                                                                                                                                              | —        | 3520 | —        | pF            |
| Reverse transfer capacitance                    |               | $C_{rss}$      |                                                                                                                                                                                                                                                                               | —        | 20   | —        |               |
| Output capacitance                              |               | $C_{oss}$      |                                                                                                                                                                                                                                                                               | —        | 300  | —        |               |
| Switching time                                  | Rise time     | $t_r$          |  <p><math>I_D = 8.0 \text{ A}</math><br/><math>R_L = 37.5 \Omega</math><br/><math>V_{DD} \approx 300 \text{ V}</math><br/>Duty <math>\leq 1\%</math>, <math>t_w = 10 \mu\text{s}</math></p> | —        | 50   | —        | ns            |
|                                                 | Turn-on time  | $t_{on}$       |                                                                                                                                                                                                                                                                               | —        | 100  | —        |               |
|                                                 | Fall time     | $t_f$          |                                                                                                                                                                                                                                                                               | —        | 60   | —        |               |
|                                                 | Turn-off time | $t_{off}$      |                                                                                                                                                                                                                                                                               | —        | 325  | —        |               |
| Total gate charge (gate-source plus gate-drain) |               | $Q_g$          | $V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 16 \text{ A}$                                                                                                                                                                                                     | —        | 80   | —        | nC            |
| Gate-source charge                              |               | $Q_{gs}$       |                                                                                                                                                                                                                                                                               | —        | 48   | —        |               |
| Gate-drain ("miller") Charge                    |               | $Q_{gd}$       |                                                                                                                                                                                                                                                                               | —        | 32   | —        |               |

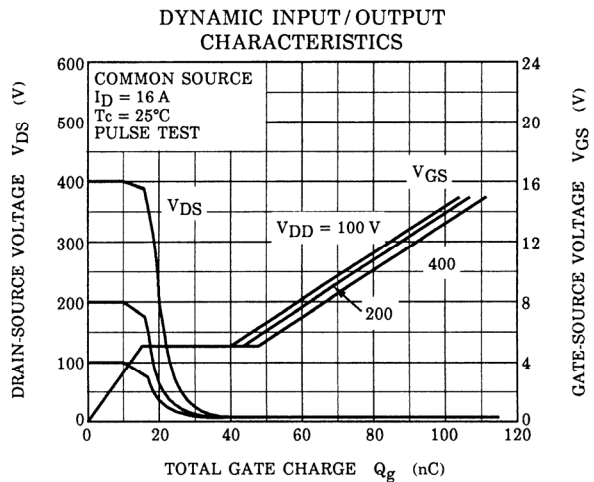
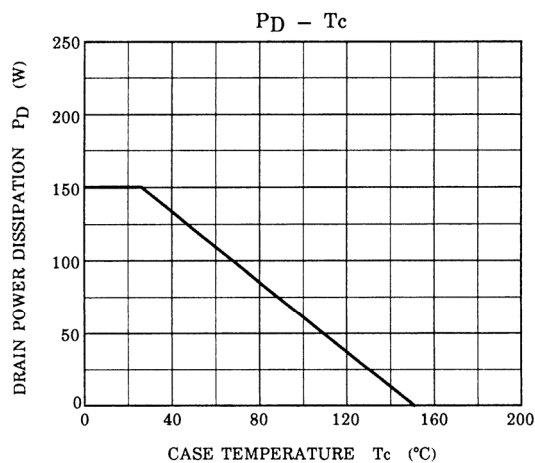
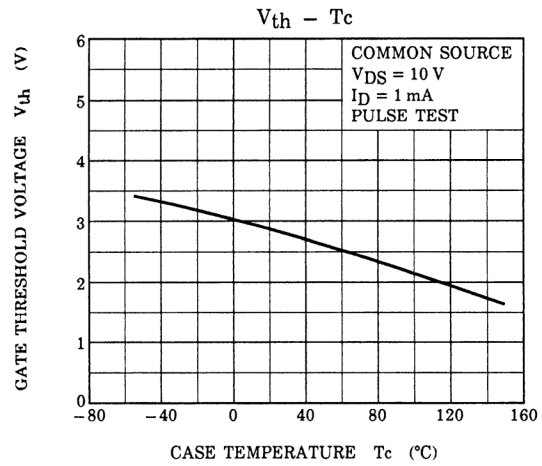
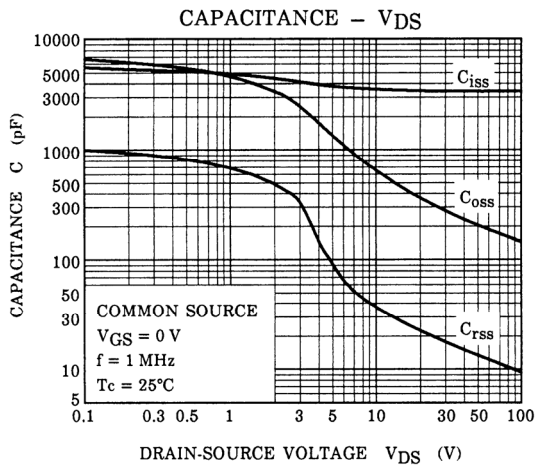
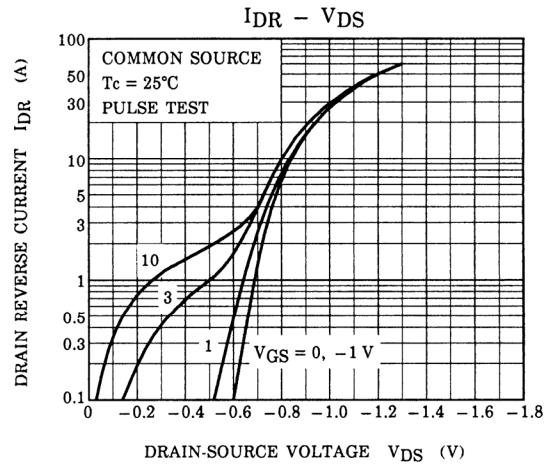
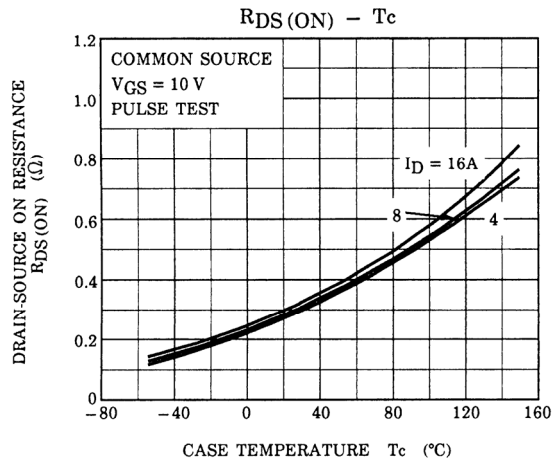
## Source-Drain Ratings and Characteristics (Ta = 25°C)

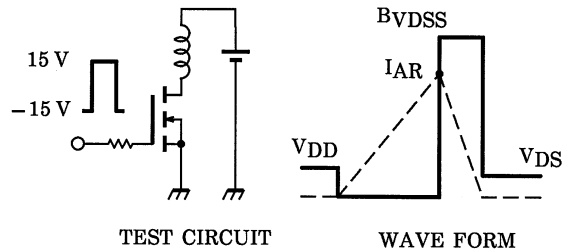
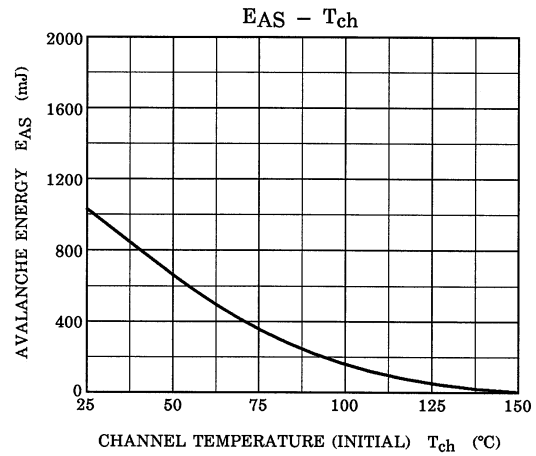
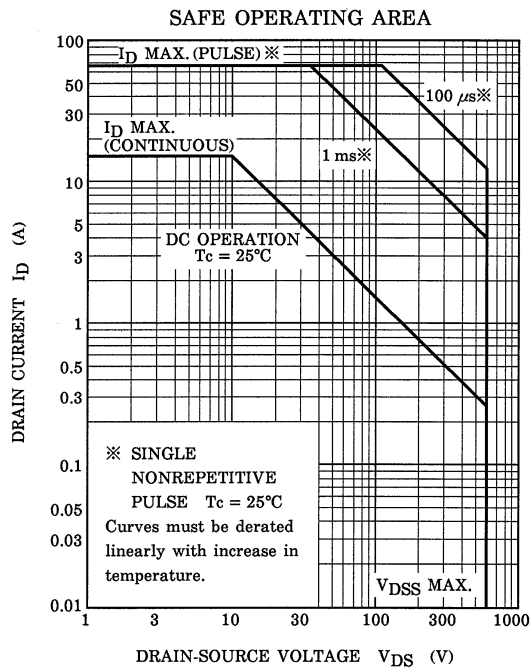
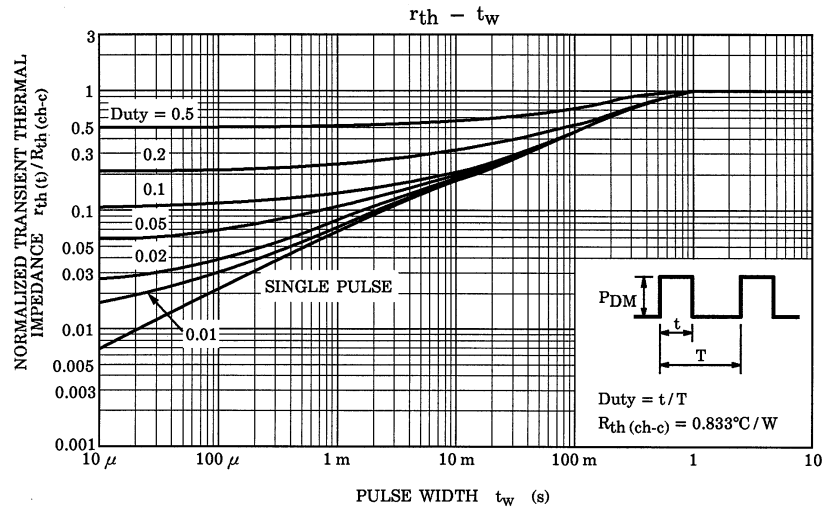
| Characteristics                           | Symbol    | Test Condition                                | Min | Typ. | Max  | Unit          |
|-------------------------------------------|-----------|-----------------------------------------------|-----|------|------|---------------|
| Continuous drain reverse current (Note 1) | $I_{DR}$  | —                                             | —   | —    | 16   | A             |
| Pulse drain reverse current (Note 1)      | $I_{DRP}$ | —                                             | —   | —    | 64   | A             |
| Forward voltage (diode)                   | $V_{DSF}$ | $I_{DR} = 16 \text{ A}, V_{GS} = 0 \text{ V}$ | —   | —    | -1.7 | V             |
| Reverse recovery time                     | $t_{rr}$  | $I_{DR} = 16 \text{ A}, V_{GS} = 0 \text{ V}$ | —   | 620  | —    | ns            |
| Reverse recovery charge                   | $Q_{rr}$  | $dI_{DR} / dt = 100 \text{ A} / \mu\text{s}$  | —   | 7.5  | —    | $\mu\text{C}$ |

## Marking









$$R_G = 25 \, \Omega$$

$$V_{DD} = 90 \, \text{V}, L = 7.01 \, \text{mH}$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_{AR}^2 \cdot \left( \frac{BVDSS}{BVDSS - V_{DD}} \right)$$

**RESTRICTIONS ON PRODUCT USE**

030619EAA

- The information contained herein is subject to change without notice.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of TOSHIBA or others.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.  
In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- TOSHIBA products should not be embedded to the downstream products which are prohibited to be produced and sold, under any law and regulations.